



Application:

Passive solution. For Intel Xeon (Dempsey) processor in 2U(up) rack-mounted server.

Specification:

Application System	2U+ Form Factor Passive Solution
CPU Type	Intel Xeon (Dempsey)
Supported CPU Frequency	3.73 GHz up; FSB 1066 MHz
Socket Type	LGA 771
Heat Sink	Copper Base + Copper Stacked Fin
Cooler Dimension	89 x 79 x 51 mm
Fastener	Screw + Spring
Interface Material	Shin Etsu 7783
CEK Spring	Provide by Motherboard

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